IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Inventor:

Hirohiko Nishiki

Serial No.:

Not Yet Assigned

Filed:

Herewith

Title:

STRUCTURE AND METHOD

FOR SUPPORTING A FLEXIBLE SUBSTRATE

PATENT APPLICATION

Attorney Docket No. **SLA 0536**

#2(IU)

Hon. Assistant Commissioner for Patents Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97

Sir:

Listed on attached Form PTO-1449 is information submitted pursuant to

37 C.F.R. §1.56. A copy of each listed publication is submitted herewith.

Applicant respectfully requests that the listed information be considered by

the Examiner and made of record in the above-identified application.

Respectfully sabmitted.

David C. Rikma, Patent Counsel Reg. No. 27,672

David C. Ripma, Patent Counsel Sharp Laboratories of America, Inc.

5750 NW Pacific Rim Boulevard, Camas, WA 98607

Facsimile:

Telephone: (360) 834-8754

(360) 834-8611

FORM PTO-1449 INFORMATION DISCLOSURE CITATION IN AN APPLICATION				DOCKET NUMBER SLA536 APPLICANT Hirohiko Nishiki		APPLICATION NUMBER O L S:06/60 GROUP ART UNIT 126/60			
				FILING DATE: GROUP ART UNIT					
				08-13-01				c971 09/	
		U.S. P	ATENT D	OCUMENTS					
EXAMINER	DOCUMENT	DATE		NAME	CL	ASS	SUB	FIL. DATE	
INITIAL	NUMBER 5,699,139	12/16/97	Aastue	n et al	349		CLASS 156	IF APPROP.	
	6,214,460	4/10/01	Bluem		428	-	355	7/5/95	
	0,214,400	4/10/01	Diucili	nucin et ar.)	333	11/12/96	
				· · · · · · · · · · · · · · · · · · ·					
							<u> </u>		
					_				
					_				
		FOREIG	N PATENT	DOCUMENTS					
	DOCUMENT NUMBER	DATE		COUNTRY/NAME	CLA	ASS	SUB CLASS	TRANSLATION YES NO	
	<u> </u>								
			<u> </u>						
		ОТ	HER DOC	UMENTS					
	article entitled, "Tri-layer a-Si:H Integrated Circuits on Polymeric Substrates", by Thomasson et al., IEDM 98, pp. 253-256.								
		· · · · · · · · · · · · · · · · · · ·	*****		A				
									
							*	-	
EXAMINER			I	DATE CONSIDERED					